

Top Marking Change for 7 Series, UltraScale, and UltraScale+ Products

XCN16014 (v1.0) July 4, 2016

Product Change Notice

Overview

The purpose of this notification is to advise customers of the phased introduction of top marking changes for Xilinx® 7 series, Zynq®-7000, Zynq® UltraScale+™, UltraScale™, and UltraScale+™ commercial / industrial "XC", Automotive "XA", and Defense-grade "XQ" devices. There is no change to fit, form, function, or reliability.

Description

Xilinx will be adding a 2D barcode to the topside marking for all Xilinx 7 series, Zynq-7000, Zynq UltraScale+, UltraScale, and UltraScale+ commercial / industrial "XC", Automotive "XA", and Defense-grade "XQ" devices. The addition of this 2D barcode allows for improved device-level traceability. The change will be introduced in phases as outlined in <u>Table 1</u> (refer to <u>XTP424</u> for transition updates).

To aid in device identification, speed, temperature grade and specification control document (SCD) information will continue to be provided in a human readable format on the moisture barrier bag labels, box labels, and invoice. An example of the device marking will also be included on the bag label as a visual guide to aid in inspection.

Through the enhanced device-level traceability provided to customers using the 2D barcode, Xilinx as a 2nd phase will be improving its delivery support and manufacturing scalability by removing selected topside marking information (line 4 speed, temperature grade and SCD information), as indicated in <u>Table 2</u> and illustrated in Phase II of <u>Figure 1</u> and <u>Figure 2</u>.

This enhanced device-level traceability also allows improved material selection based on individual device performance rather than date code and lot number. Xilinx will be combining devices in a shipment based on the device performance characteristics rather than controlling combinations by lot or date codes.

The 2D barcode contains a unique serial number that must be scanned using a camera based application to determine the serial number. The device's speed grade, temperature grade and SCD that were previously found on line 4 can only be retrieve using the unique serial number through an internet based application either on a mobile device or through a web browser using a portal (refer to <u>XTP424</u> for details). Scanning the existing License Plate Number (LPN) provided on the inner box and bag label will allow access to all device information and codes contained within a specific bag or box using the same portal.

Products Affected

This change affects all package, speed, and temperature grade variations for Xilinx 7 series, Zynq-7000, Zynq UltraScale+, UltraScale, and UltraScale+ commercial / industrial "XC", Automotive "XA", and Defense-grade "XQ" devices, including SCD product.

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Product Line	Device	Anticipated Shipments
XC	Zynq UltraScale+, and UltraScale+	Now – Shipping Engineering Samples (ES)
XC	7 series, Zynq-7000, and UltraScale	November 2016
XA	7 series, Zynq-7000, and Zynq UltraScale+	November 2016
XQ	7 series, Zynq-7000, UltraScale, Zynq UltraScale+, and UltraScale+	November 2016

Table 2: Marking Simplification (line 4 speed, temperature grade, and SCD) - Phase II (Figures 1 and 2)

Product Line	Device	Anticipated Shipments
XC	Zynq UltraScale+*, and UltraScale+*	Upon Production Release
XC	7 series, Zynq-7000, and UltraScale	May 2017
XA	7 series, Zynq-7000, and Zynq UltraScale+*	July 2017

*Note: UltraScale+ products will not be marked with lot number or date code.

Key Dates and Ordering Information

Xilinx will begin cross shipping devices with either mark as indicated in <u>Table 1</u> and <u>Table 2</u> above. For exact transition dates, please refer to Xilinx <u>XTP424</u>.

Traceability

Affected devices are identified by the following package top marks as shown in Figure 1 and Figure 2.







Figure 2: Product marking examples

Response

No response is required. For additional information or questions, please contact Xilinx Technical Support.

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Revision History

The following table shows the revision history for this document.

Date	Version	Description of Revisions	
07/04/2016	1.0	Initial release.	

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